

# **Application Note: SY59515**

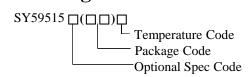
Charge Pump PFC LLC Low side controller, High PF, Low THD

## **General Description**

SY59515 is the low side LLC controller integrated with a 500V MOSFET, it is used in charge pump PFC application. High PF is achieved by inherent PFC function and low LED current ripple is achieved by LLC topology. Single stage structure and primary side regulation save BOM cost a lot. Meanwhile, LLC topology improves efficiency and EMI.

It should work with SY59516, which is the high side LLC controller integrated with a 500V MOSFET.

## **Ordering Information**



Ordering Number	Package type	Note
SY59515FAC	SO8	

### **Features**

- Integrated 500V MOSFET
- Charge Pump PFC LLC Topology with Low BOM Cost
- PF>0.95, THD<20%
- Primary Side I<sub>LED</sub> Regulation and Less than 2% I<sub>LED</sub> Ripple
- Short LED Protection (SLP), Open LED Protection (OLP), E-cap over Voltage Protection (HV OVP)
- Zero Voltage Overshoot on Resonant Capacitor at Startup
- Compact Package: SO8

# **Applications**

LED Lighting

Recon	nmended operating	output power @ Vout=42V
	Products	198~264Vac
	SY59515	42W

# **Typical Applications**

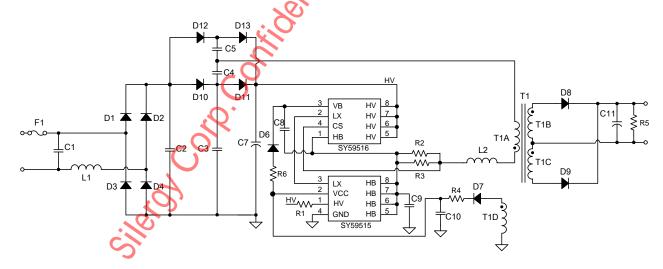
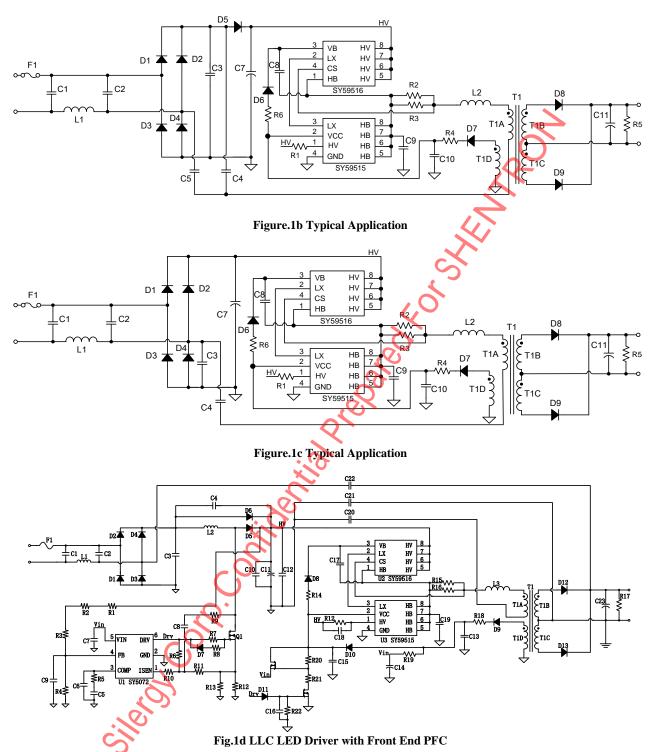


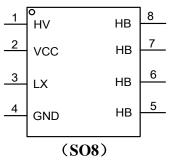
Figure.1a Typical Application





## Pinout (top view)





**Top Mark: CUG** xyz (device code: CUG, x=year code, y=week code, z= lot number code)

Pin Name	Pin number	Pin Description
HV	1	HV start pin, HV OVP and HV UVP sense pin.
VCC	2	Bias supply for low side circuit, LED OVP detection.
LX	3	Low side driver control pin.  This pin receives the control signal from \$Y59516, internal voltage comparator and slope detection circuit can provide reliable switching strategy of internal MOSFET.
GND	4	Ground pin for low side circuit. Source of low side internal 500V MOSFET.
НВ	5-8	Drain of internal 500V MOSFET.

# **Block Diagram**

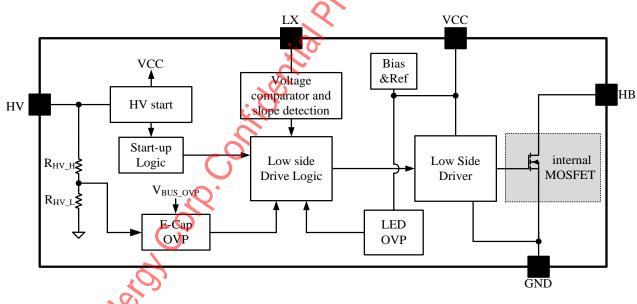


Figure.3 Block Diagram



<b>Absolute Maximum Ratings</b> (Note	Al	bsolu	te M	[axi	mum	Ra	tings	(Note 1	1)
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HV	
VCC	
LX	
HB	
Power Dissipation, @ TA = 25°C SO8	1.1W
Package Thermal Resistance (Note 2)	
SO8, $\theta_{JA}$	88°C/W
SO8, $\theta_{JC}$	45°C/W
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 10 sec.)	
Storage Temperature Range	

### **Recommended Operating Conditions**

### **Electrical Characteristics**

 $(V_{IN} = 15V, T_A = 25^{\circ}C \text{ unless otherwise specified})$ 

Low Side Controller		(8)				
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Power Supply Section</b>		0				
VCC Turn-on Threshold	$V_{VCC\_ON}$	401	10.6	11.4	12.2	V
VCC Turn-off Threshold	$V_{VCC\_OFF}$	Q	7.2	7.9	8.6	V
VCC OVP Voltage	$V_{VCC\_OVP}$		26.0	27.8	29.6	V
Quiescent Current	$I_Q$	before V <sub>VCC_ON</sub>	190	245	300	μΑ
HV Start up Current	I <sub>ST_HV</sub>	7	1.4	2.0	2.6	mA
MOSFET Section	70,					
MOSFET Rdson	R <sub>dson</sub>		0.75	1	1.25	Ω
Breakdown Voltage	$V_{BV}$	$V_{GS}=0, I_{DS}=250 \mu A$	500	540		V
HV Section	,0					
HV OVP	V <sub>HV_OVP</sub>		455	483	511	V
HV UVP	$V_{HV\_UVP}$		160	178	196	V
Logic Section						
MIN_ON	T <sub>MIN_ON</sub>		400	525	650	ns

**Note 1**: Stresses beyond the "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2:  $\Theta_{JA}$  is measured in the natural convection at  $T_A = 25^{\circ}\text{C}$  on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard. Test condition: Device mounted on 2" x 2" FR-4 substrate PCB, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane.



## **Operation**

SY59515 is the low side LLC controller integrated with a 500V MOSFET, it is used in charge pump PFC application, which is targeting at LED lighting applications. High PF is achieved by inherent PFC function and low LED current ripple is achieved by LLC topology. Single stage structure and primary side regulation save BOM cost a lot.

SY59515 contains reliable turn on and turn off logic, which can avoid LLC half bridge shoot through and support high switching frequency more than 200kHz. SY59515 also adopts special design to achieve zero voltage overshoot on resonant capacitor at startup. It also uses slope detection function to make sure the valley turn on of MOSFET to achieve higher efficiency.

LLC topology improves efficiency and EMI, furthermore, one external NPO capacitor can be put between midpoint between LLC half bridge and GND point (or BUS point) to further improve system performance.

SY59515 provides reliable protections including short circuit protection (SCP), open LED protection (OLP), and E-cap over voltage protection (HV OVP).

SY59515 is available with SO8 package, and should work with SY59516, which is the high side LLC controller integrated with a 500V MOSFET.

# **Applications Information**

#### Start up

After AC supply or DC BUS is powered on, capacitor  $C_{VCC}$  across VCC and GND pin is charged by internal current source. This current source comes from HV pin, which is connected to  $V_{BUS}$  through one external resistor  $R_{HV\_EXT}$ .

The whole start up process can be divided into 4 sections shown in Fig.3, HO and LO are internal gate of SY59516 and SY59515, respectively.  $t_{STC1}$  is the  $C_{VCC}$  charging up section.  $t_{STD}$  is midpoint HB voltage and HV voltage detecting section, during this time,  $C_{VCC}$  will charge back and forth between  $V_{VCC\_ON}$  and  $V_{VCC\_OFF}$ , until HB voltage is below 6V and HV voltage is lower than HV OVP. SY59515 provides a constant internal current to pull down HB voltage through LX pin, so when MOSFET of SY59515 is turned on, there won't be large resonant current flowing through resonant capacitor. After the above two conditions are met, SY59515 will exit  $t_{STD}$  stage and enter into  $t_{STC2}$  stage.  $t_{STC2}$  is the  $C_{VCC}$  together with  $C_{VB}$  charging up section,

once  $V_{VB}$  reaches  $V_{VB\_ON}$ , internal MOSFET of SY59515 is turned off, switching control starts to work and HV pin stops to provide charge current.  $t_{STO}$  is the output voltage building up section,  $V_{VCC}$  and  $V_{VB}$  will be pulled down by internal consumption current until the auxiliary winding of LLC transformer can supply enough energy to maintain  $V_{VCC}$  above  $V_{VCC\_OFF}$ .

Design of HV pin resistor  $R_{HV}$  ext.  $C_{VCC}$  and  $C_{VB}$  is not strict, below are some suggestions:

- a) Use  $R_{HV\_EXT}$  smaller than 200kohms, resistance of  $R_{HV\_EXT}$  will influence E-cap over voltage protection (HV OVP).
- b) Use  $C_{VCC}$  larger than 470nF, use  $C_{VB}$  larger than 100nF, there no need to use very large  $C_{VCC}$  or  $C_{VB}$  capacitor, suggest using 2uF  $C_{VCC}$  and 1uF  $C_{VB}$ .
- c) If  $C_{VCC}$  and  $C_{VB}$  are not big enough to build up output voltage at one time, increase  $C_{VCC}$  and  $C_{VB}$ , or check whether the output E-cap is too large.

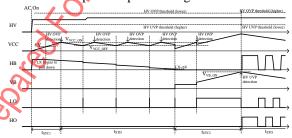


Fig.3 Start up Process of SY59515 and SY59516

After  $V_{VB\_ON}$  and high side MOSFET is turned on, soft start up function works, it prevents resonant current from being too high at start up. Switching frequency is fixed at maximum switching frequency  $f_{SW\_MAX}$  during the first few resonant periods.

### Shut down

After AC supply or DC BUS is powered off, LLC still works for a while to consume the energy stored in input E-cap. During this time, auxiliary winding can still provide stable VCC voltage so SY59515 and SY59516 can continue with the internal working logic. Once HV pin voltage reaches E-cap under voltage protection (HV UVP), SY59515 will keep internal MOSFET off and SY59516 will turn off its internal MOSFET soon.. Once high side and low side MOSFET are turned off, C<sub>VCC</sub> and C<sub>VB</sub> will discharge, discharge current of C<sub>VCC</sub> is quiescent current of SY59515 and discharge current of C<sub>VB</sub> is constant 6mA. Usually, V<sub>VB</sub> reaches V<sub>VB\_OFF</sub> earlier than  $V_{VCC}$  reaches  $V_{VCC\_OFF}$ . When  $V_{VB}$  reaches V<sub>VB OFF</sub>, 6mA discharge current will be removed. When V<sub>VCC</sub> reaches V<sub>VCC OFF</sub>, SY59515 will restart and HV pin starts to provide charge current.

To avoid flashback after shut down, SY59515 adopts a hysteresis loop at HV UVP threshold, the lower

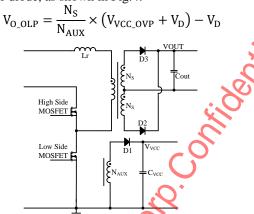


threshold is used at normal shut down process, and the higher threshold is used at start up process. After  $V_{VB}$  reaches  $V_{VB\_ON}$ , SY59515 detects HV voltage to determine whether it's enough. So after system shut down, HV voltage needs to be higher to restart up successfully and flashback is avoided.

# Short LED protection (SLP), open LED protection (OLP), E-cap over voltage protection (HV OVP)

SLP: When output is in short circuit condition, auxiliary winding cannot provide charge current to  $C_{VCC}$ , so  $C_{VCC}$  and  $C_{VB}$  will discharge synchronously by operating current consumption. Once  $V_{VB}$  reaches  $V_{VB\_OFF}$ , SY59516 will turn off MOSFET and pull down LX pin from VB to HB. Later when  $V_{VCC}$  reaches  $V_{VCC\_OFF}$ , SY59515 begins to restart.

OLP: Output voltage is reflected by auxiliary winding of LLC transformer,  $V_{\rm VCC}$  is proportional to output voltage. When the load is null, secondary side current of LLC transformer will charge output E-cap continuously and  $V_{\rm VCC}$  will increase. Once  $V_{\rm VCC}$  reaches  $V_{\rm VCC\_OVP},$  SY59515 will enter fault state and system will restart later. So the turns of auxiliary winding  $N_{\rm AUX}$  and secondary winding  $N_{\rm S}$  will influence the output voltage  $V_{\rm O\_OLP}$  in OLP situation,  $V_{\rm D}$  is the voltage drop of rectifier diode, as shown in Fig.4.



HV OVP: When AC supply or DC BUS is too high, or surge comes, or in output short circuit condition,  $V_{BUS}$  may be over voltage, which will lead to the failure of input E-cap or internal MOSFET in SY59515 and SY59516. There is a resistor divider composed of one external HV pin resistor  $R_{HV\_EXT}$  and two internal HV pin resistors. Two internal HV resistors are  $R_{HV\_H}$  and  $R_{HV\_L}$ , their resistance are  $4M\Omega$  and  $10k\Omega$ . As shown in Fig.5, voltage across  $R_{HV\_L}$  is used to compare with  $V_{BUS\_OVP}$ , the actual  $V_{BUS}$  in HV OVP can be calculated as below:

Fig.4 OLP Principle of SY59515

$$V_{HV\_OVP} = \frac{R_{HV\_EXT} + R_{HV\_H} + R_{HV\_L}}{R_{HV\_L}} \times V_{BUS\_OVP}$$

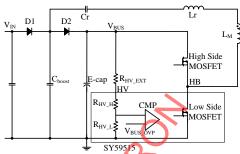


Fig.5 HV OVP Principle of SY59515

 $R_{HV\_H},~R_{HV\_L}$  and  $V_{BUS\ OVP}$  all influence  $V_{HV\_OVP},$  and  $V_{HV\_OVP}$  is the key parameter that affect the system, so  $V_{HV\_OVP}$  with  $0\Omega$   $R_{HV\_EXT}$  is provided in electrical characteristics table. Besides,  $R_{HV\_EXT}$  can adjust  $V_{HV\_OVP}$  within a certain range.

SY59515 adopts a hysteresis loop at HV OVP threshold, the lower threshold is only used during  $t_{STD}$  at start up process. After  $V_{VB}$  reaches  $V_{VB\_ON}$ , HV OVP threshold turns to the higher one. This hysteresis loop is used to avoid the system locked in the HV OVP state at some very special situations.

## **Magnetic Element Design**

According to the design table, calculate the resonant inductor, resonant capacitor and boost capacitor. Left part of design table is one standard design with good performance, this topology has good normalized property, which means the resonant parameters is related to output current  $I_{\rm O}$ , resonant frequency  $f_{\rm r}$  and maximum output voltage  $V_{\rm O\_MAX}$ .

### **Induct**or

System works in LC resonant condition, the peak value and RMS value of resonant current can be calculated:

$$\begin{split} I_{r\_peak} &= 2 \times I_0/N_{ps} \\ I_{RMS} &= \frac{I_{r\_peak}}{\sqrt{3}} \end{split}$$

Usually select  $B_{max\_ind}$  between 0.2 and 0.3, so turn number of inductor can be calculated:

$$n_{ind} = \frac{I_{r\_peak} \times L_r}{A_{e\_ind} \times B_{max\_ind}}$$

It's recommended to use litz wire for lower temperature rise. Current density  $j_{ind}$  is selected at  $8A/mm^2$ , so the number of 0.1mm enameled wire  $n_{litz}$  can be calculated:

$$n_{litz} = \frac{4 \times I_{RMS}}{\pi \times j_{ind} \times 0.1^2}$$

#### **Transformer**

RMS value of primary winding current is the same as inductor, so the wire diameters of primary and secondary



winding are easy to get. Usually select  $B_{\text{max\_trans}}$  as 0.3, and the turn number of primary winding can be calculated:

$$\begin{split} n_{p\_trans} &= \frac{V_{O\_MAX} \times n_{ps}}{4 \times f_r \times B_{max\_trans} \times A_{e\_trans}} \\ n_{s\_trans} &= \frac{n_{s\_trans}}{n_{ps}} \end{split}$$

The auxiliary winding should satisfy the following conditions:

$$V_{O\_OLP} + V_D = \frac{N_S}{N_{AUX}} \times (V_{VCC\_OVP} + V_D)$$
$$(V_{O\_MIN} + V_D) \times \frac{N_{AUX}}{N_S} - V_D > 13V$$

No air gap is required for transformer cores, large inductance of primary winding is needed, it's suggested that the ratio of inductance of primary winding and resonant inductor be larger than 3. If the ratio is small, it needs to change the bobbin and core size of inductor or transformer.

#### **Magnetic Integrated Design**

It's recommended to use magnetic integrated design for better efficiency and power density. In this design, leakage inductance of transformer primary winding is used as resonant inductor, so the key of magnetic integrated design is the control of leakage inductance. Fig.6 shows the structure of magnetic integrated transformer, primary and secondary windings are placed at left side and right side, respectively, between them is a big gap for larger leakage inductance. Leakage inductance mainly depends on the turn number of primary winding, bobbin size and the big gap in the middle. Red line represents the leakage inductance of primary winding, which is equivalent to the role of resonant inductor, and the green line represents the transformer excitation loop.

In magnetic integrated design, usually it's no need to consider the inductance ratio between primary winding and resonant inductor, because the bobbin size of transformer becomes larger than discrete design, the excitation inductance is much larger.

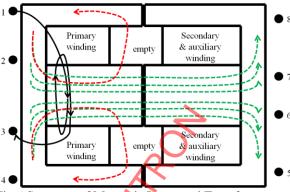
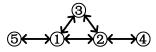


Fig.6 Structure of Magnetic Integrated Transformer

## Layout

- (a) Because of the charge pump structure, it's not necessary to put the input E-cap close to bridge rectifier. Make sure the loop composed of input E-cap, HV of SY59516, HB of SY59516, HB of SY59515 and GND of SY59515 to be as small as possible.
- (b) The circuit loop of CS sampling should be kept small.
- (c) The C<sub>VB</sub> charge loop should be kept small, C<sub>VB</sub> should be put near SY59516.
- (d) The  $C_{VCC}$  and  $N_{AUX}$  charging loop should be kept small,  $C_{VCC}$  should be put near SY59515.
- (e) Not recommend to put high voltage track under low voltage components, such as HV and LX.
- (f) Recommend to use a high voltage MLCC in parallel with input E-cap, recommend to connect the core of inductor to low frequency input line after filter.
- (g) The connection of ground is recommended as:



Ground ①: ground of input E-cap

Ground ②: ground of SY59515 and Cvcc

Ground ③: ground of external high voltage NP0 MLCC

Ground 4: ground of auxiliary winding

Ground ⑤: ground of bridge rectifier and Cboost

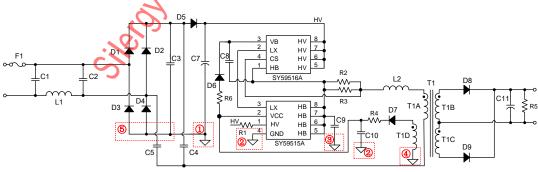


Fig.7 Ground Connection Recommended



## **Design Example**

Table 1 and table 2 show the key parameters of standard design in design table and parameters defined by the customer, respectively. The relationship between them is also provided.

System Conditions		7
Maximum Output Voltage	V <sub>O_MAX_S</sub>	42V
Output Current	I <sub>O_S</sub>	1A
Output Diode Drop	$V_{DF\_S}$	1.3V
Main Resonant Frequency	$f_{r\_S}$	52.5kHz
Key Parameters		47
Turns Ratio	N <sub>PS_S</sub>	1.75
Sampling Resistor	R <sub>CS_S</sub>	0.26Ω
Resonant Inductor	$L_{r\_S}$	700uH
Main Resonant Capacitor	$C_{r\_S}$	27nF
Minor Resonant Capacitor	C <sub>r2_S</sub>	3.3nF
Boost Capacitor	C <sub>boost_S</sub>	15nF
Input E-cap	C <sub>in_S</sub>	45uF

### Table 2 Parameters Defined by Customer

System Conditions	40	
Maximum Output Voltage	V <sub>O_MAX_C</sub>	40V
Output Current	$I_{O\_C}$	0.8A
Output Diode Drop	$V_{\mathrm{DF}\_\mathrm{C}}$	1.3V
Main Resonant Frequency	$f_{r\_C}$	70kHz
Key Parameters	(V)	
Turns Ratio	N <sub>PS_C</sub>	1.83
Sampling Resistor	R <sub>CS_C</sub>	0.34Ω
Resonant Inductor	$L_{r\_C}$	689uH
Main Resonant Capacitor	Crc	15.4nF
Minor Resonant Capacitor	C <sub>r2_c</sub>	1.9nF
Boost Capacitor	C <sub>boost_C</sub>	8.6nF
Input E-cap	C <sub>in_C</sub>	11uF



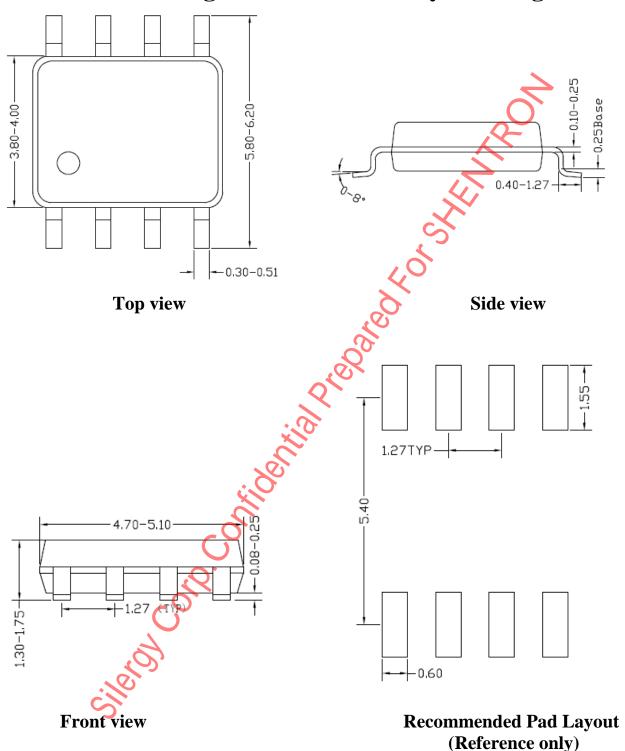


 $C_{in\_C} = C_{in\_S} \times \frac{V_{O\_MAX\_C} \times I_{O\_C}}{V_{O\_MAX\_S} \times I_{O\_S}}$   $V_{O\_MAX\_C}, I_{O\_C}, V_{DF\_C} \text{ and } f_{r\_C} \text{ are defined by customer, and other key parameters will be calculated according to the state of the content of the content$ above normalization formula.

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# SO8 Package outline & PCB layout design



Notes: All dimension in millimeter and exclude mold flash & metal burr.



# **Revision History**

The revision history provided is for informational purpose only and is believed to be accurate, however, not warranted. Please make sure that you have the latest revision.

Date	Revision	Change
December 28.2021	Revision 0.9	Initial Release



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